



Features

- Logic Level Input
- Input Protection (ESD)
- Thermal shutdown with latch

RoHS

- Green product (RoHS compliant)
- Short circuit and Overload protection
- Overvoltage protection
- Current limitation
- Status feedback with external input resistor
- Analog driving possible
- AEC qualified
- Green product (RoHS compliant)

Application

- All kinds of resistive, inductive and capacitive loads in switching or linear applications
- \bullet μC compatible power switch for 12 V and 24 V DC applications
- Replaces electromechanical relays and discrete circuits

General Description

N channel vertical power FET in Smart SIPMOS[®] chip on chip technology. Providing embedded protection functions.



Product Summary

Drain source voltage	V _{DS}	60	V
On-state resistance	R _{DS(on)}	50	mΩ
Current limit	I _{D(lim)}	21	А
Nominal load current	I _{D(ISO)}	7	А
Clamping energy	E _{AS}	2000	mJ





Parameter	Symbol	Value	Unit		
Drain source voltage	V _{DS}	60	V		
Drain source voltage for short circuit protection	V _{DS(SC)}	32			
Continuous input current ¹⁾	I _{IN}		mA		
$-0.2V \le V_{\rm IN} \le 10V$		no limit			
$V_{\rm IN}$ < -0.2V or $V_{\rm IN}$ > 10V		<i>I</i> _{IN} ≤ 2			
Operating temperature	Tj	- 40 +150	°C		
Storage temperature	T _{stg}	- 55 +150			
Power dissipation	P _{tot}	90	W		
$T_{\rm C} = 25 \ ^{\circ}{\rm C}$					
Unclamped single pulse inductive energy	E _{AS}	2000	mJ		
$I_{D(ISO)} = 7 A$					
Electrostatic discharge voltage (Human Body Model)	V _{ESD}	3000	V		
according to MIL STD 883D, method 3015.7 and					
EOS/ESD assn. standard S5.1 - 1993					
Load dump protection $V_{\text{LoadDump}}^{(2)} = V_{\text{A}} + V_{\text{S}}$	V _{LD}				
V _{IN} =low or high; V _A =13.5 V					
t _d = 400 ms, <i>R</i> I = 2 Ω, <i>I</i> D=0,5*7A		90			
t _d = 400 ms, <i>R</i> _I = 2 Ω, <i>I</i> _D = 7A		74			

Maximum Ratings at Tj = 25 °C unless otherwise specified

Thermal resistance

junction - case:	R _{thJC}	1.4	K/W
junction - ambient:	R _{thJA}	75	
SMD version, device on PCB: ³⁾	R _{thJA}	45	

¹In case of thermal shutdown a minimum sensor holding current of 500 μ A has to be guaranteed (see also page 3).

 $^{2}V_{Loaddump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

³ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for Drain connection. PCB mounted vertical without blown air.



Electrical Characteristics

Parameter	Symbol	Values			Unit
at T _j =25°C, unless otherwise specified		min.	typ.	max.]
Characteristics	•	·	·		·
Drain source clamp voltage	V _{DS(AZ)}	60	-	73	V
<i>T</i> _j = - 40+ 150°C, <i>I</i> _D = 10 mA					
Off state drain current	I _{DSS}	-	-	10	μA
V_{DS} = 32 V, T_{j} = -40+150 °C, V_{IN} = 0 V					
Input threshold voltage	V _{IN(th)}	1.3	1.7	2.2	V
<i>I</i> _D = 1,4 mA					
Input current - normal operation, <i>I</i> _D < <i>I</i> _{D(lim)} :	/IN(1)	-	30	55	μA
V _{IN} = 10 V					
Input current - current limitation mode, $I_{\rm D}=I_{\rm D(lim)}$:	I _{IN(2)}	60	150	350]
$V_{\rm IN} = 10 \text{ V}$					
Input current - after thermal shutdown, <i>I</i> _D =0 A:	I _{IN(3)}	1000	2500	4000	1
V _{IN} = 10 V					
Input holding current after thermal shutdown ¹⁾	I _{IN(H)}				
<i>T</i> _j = 25 °C		500	-	-	
<i>T</i> _j = 150 °C		300	-	-	
On-state resistance	R _{DS(on)}				mΩ
$V_{\rm IN}$ = 5 V, $I_{\rm D}$ = 7 A, $T_{\rm j}$ = 25 °C		-	50	60	
V _{IN} = 5 V, <i>I</i> _D = 7 A, <i>T</i> _j = 150 °C		-	90	120	
On-state resistance	R _{DS(on)}				1
V _{IN} = 10 V, <i>I</i> _D = 7 A, <i>T</i> _j = 25 °C	- ()	-	40	50	
$V_{\rm IN}$ = 10 V, $I_{\rm D}$ = 7 A, $T_{\rm j}$ = 150 °C		-	75	100	
Nominal load current (ISO 10483)	I _{D(ISO)}	7	-	-	А
$V_{\rm IN}$ = 10 V, $V_{\rm DS}$ = 0.5 V, $T_{\rm C}$ = 85 °C					



Electrical Characteristics

Parameter	Symbol	Values			Unit
at T _j =25°C, unless otherwise specified		min.	typ.	typ. max.	
Characteristics					
Initial peak short circuit current limit	I _{D(SCp)}	-	65	-	А
V _{IN} = 10 V, V _{DS} = 12 V					
Current limit ¹⁾	I _{D(lim)}	21	28	40	1
$V_{\rm IN}$ = 10 V, $V_{\rm DS}$ = 12 V, $t_{\rm m}$ = 350 µs,					
<i>T</i> _j = -40+150 °C					
Dynamic Characteristics					•
Turn-on time $V_{\rm IN}$ to 90% $I_{\rm D}$:	t _{on}		40	100	μs
$R_{\rm L}$ = 2,2 Ω, $V_{\rm IN}$ = 0 to 10 V, $V_{\rm bb}$ = 12 V					
Turn-off time V _{IN} to 10% I _D :	<i>t</i> off		70	170	
$R_{\rm L}$ = 2,2 Ω, $V_{\rm IN}$ = 10 to 0 V, $V_{\rm bb}$ = 12 V					
Slew rate on 70 to 50% V _{bb} :	-dV _{DS} /dt _{on}		1	3	V/µs
$R_{\rm L}$ = 2,2 Ω, $V_{\rm IN}$ = 0 to 10 V, $V_{\rm bb}$ = 12 V					
Slew rate off 50 to 70% V _{bb} :	dV _{DS} /dt _{off}		1	3]
$R_{\rm L}$ = 2,2 Ω, $V_{\rm IN}$ = 10 to 0 V, $V_{\rm bb}$ = 12 V					
Protection Eurotiana ²⁾	+				•

Protection Functions²⁾

Thermal overload trip temperature	T _{it}	150	165	-	°C
Unclamped single pulse inductive energy	E _{AS}				mJ
$I_{\rm D}$ = 7 A, $T_{\rm j}$ = 25 °C, $V_{\rm bb}$ = 32 V		2000	-	-	
$I_{\rm D}$ = 7 A, $T_{\rm j}$ = 150 °C, $V_{\rm bb}$ = 32 V		450	-	-	

Inverse Diode

Inverse diode forward voltage	V _{SD}	-	1.08	-	V
$I_{\rm F}$ = 5*7A, $t_{\rm m}$ = 300 µS, $V_{\rm IN}$ = 0 V					

¹Device switched on into existing short circuit (see diagram Determination of I $_{D(lim)}$). If the device is in on condition and a short circuit occurs, these values might be exceeded for max. 50 µs.

²Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.



Block Diagramm

Terms



Input circuit (ESD protection)



ESD zener diodes are not designed for DC current > 2 mA @ V_{IN} >10V.

Inductive and overvoltage output clamp



Short circuit behaviour



- t₀: Turn on into a short circuit
- t_m: Measurementpoint for I_{D(lim)}
- t₁: Activation of the fast temperature sensor and regulation of the drain current to a level where the junction temperature remains constant.
- t₂: Thermal shutdown caused by the second temperature sensor, achieved by an integrating measurement.



Maximum allowable power dissipation P_{tot} = f(T_c)



On-state resistance R_{ON} = f(T_j); I_D= 7A; V_{IN}=5V



On-state resistance R_{ON} = f(T_i); I_D=7A; V_{IN}=10V



Typ. input threshold voltage V_{IN(th)} = f(T_j); I_D=1,4mA; V_{DS}=12V



Datasheet





Typ. transfer characteristics $I_D = f(V_{IN}); V_{DS}=12V; T_j=25^{\circ}C$



Transient thermal impedance

 $Z_{\text{thJC}} = f(t_{\text{p}})$



Typ. output characteristic $I_D = f(V_{DS}); T_j=25^{\circ}C$ Parameter: V_{IN}





Application examples:

Status signal of thermal shutdown by monitoring input current



 $\Delta V = R_{ST} * I_{IN(3)}$



Package Outlines

1 Package Outlines



Figure 1 PG-TO220-3-5 (Plastic Dual Small Outline Package) (RoHS-Compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products.



Revision History

2 Revision History

Version	Date	Changes
Rev. 1.3	2008-12-10	released automotive green and robust version Package drawing updated
Rev. 1.2	2008-08-11	Package information updated, removed through hole versions
Rev. 1.1	2008-02-22	Package parameter (humidity and climatic) removed in Maximum ratings AEC icon and RoHS icon added Green product and AEC qualified added to the feature list added Protection footnote on Page 4 and changed front page general description Package information updated to green Green explanation added
Rev. 1.0	2000-05-19	released production version

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